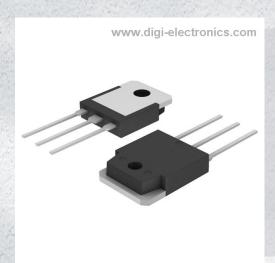


FDA28N50 Datasheet



https://www.DiGi-Electronics.com

DiGi Electronics Part Number FDA28N50-DG

Manufacturer onsemi

Manufacturer Product Number FDA28N50

Description MOSFET N-CH 500V 28A TO3PN

Detailed Description N-Channel 500 V 28A (Tc) 310W (Tc) Through Hole

TO-3PN



Tel: +00 852-30501935

RFQ Email: Info@DiGi-Electronics.com

DiGi is a global authorized distributor of electronic components.



Purchase and inquiry

Manufacturer Product Number:	Manufacturer:
FDA28N50	onsemi
Series:	Product Status:
UniFET™	Active
FET Type:	Technology:
N-Channel	MOSFET (Metal Oxide)
Drain to Source Voltage (Vdss):	Current - Continuous Drain (Id) @ 25°C:
500 V	28A (Tc)
Drive Voltage (Max Rds On, Min Rds On):	Rds On (Max) @ Id, Vgs:
10V	155m0hm @ 14A, 10V
Vgs(th) (Max) @ ld:	Gate Charge (Qg) (Max) @ Vgs:
5V @ 250μA	105 nC @ 10 V
Vgs (Max):	Input Capacitance (Ciss) (Max) @ Vds:
±30V	5140 pF @ 25 V
FET Feature:	Power Dissipation (Max):
	310W (Tc)
Operating Temperature:	Mounting Type:
-55°C ~ 150°C (TJ)	Through Hole
Supplier Device Package:	Package / Case:
TO-3PN	TO-3P-3, SC-65-3
Base Product Number:	
EDA28	

Environmental & Export classification

8541.29.0095

RoHS Status:	Moisture Sensitivity Level (MSL):
ROHS3 Compliant	Not Applicable
REACH Status:	ECCN:
REACH Unaffected	EAR99
HTSUS:	



MOSFET - N-Channel, UniFET™

500 V, 28 A, 155 mΩ

FDA28N50

Description

UniFET MOSFET is onsemi's high voltage MOSFET family based on planar stripe and DMOS technology. This MOSFET is tailored to reduce on-state resistance, and to provide better switching performance and higher avalanche energy strength. This device family is suitable for switching power converter applications such as power factor correction (PFC), flat panel display (FPD) TV power, ATX and electronic lamp ballasts.

Features

- $R_{DS(on)} = 122 \text{ m}\Omega \text{ (Typ.)} @ V_{GS} = 10 \text{ V}, I_D = 14 \text{ A}$
- Low Gate Charge (Typ. 80 nC)
- Low Crss (Typ. 42 pF)
- 100% Avalanche Tested
- This Device is Pb-Free Halide, Free and RoHS Compliant

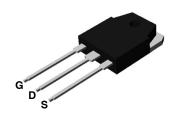
Applications

- PDP TV
- Uninterruptible Power Supply
- AC-DC Power Supply

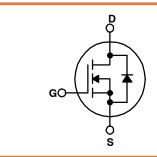
MOSFET MAXIMUM RATINGS (T_C = 25°C unless otherwise noted.)

Symbol	Parameter	Value	Unit
V _{DSS}	Drain to Source Voltage	500	V
V _{GSS}	Gate to Source Voltage	±30	V
I _D	Drain Current - Continuous (T _C = 25°C) - Continuous (T _C = 100°C)	28 17	Α
I _{DM}	Drain Current - Pulsed (Note 1)	112	Α
E _{AS}	Single Pulsed Avalanche Energy (Note 2)	2391	mJ
I _{AR}	Avalanche Current (Note 1)	28	Α
E _{AR}	Repetitive Avalanche Energy (Note 1)	31	mJ
dv/dt	Peak Diode Recovery dv/dt (Note 3)	5	V/ns
P _D	Power Dissipation – (T _C = 25°C) – Derate Above 25°C	310 2.5	W W/°C
T _J ,T _{STG}	Operating and Storage Temperature Range	-55 to +175	°C
TL	Maximum Lead Temperature for Soldering Purposes, 1/8" from case for 5 seconds	300	°C

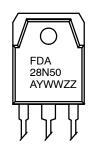
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.



TO-3P-3L CASE 340BZ



MARKING DIAGRAM



FDA28N50

77

YWW

= Specific Device Code = Assembly Location

= Date Code (Year and Week) = Assembly Lot Code

ORDERING INFORMATION

Device	Package	Shipping [†]
FDA28N50	TO-3P-3L (Pb-Free)	450 Units / Tube

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

THERMAL CHARACTERISTICS

Symbol	Parameter	Value	Unit
$R_{ heta JC}$	Thermal Resistance, Junction to Case, Max	0.4	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient, Max.	40	

ELECTRICAL CHARACTERISTICS ($T_C = 25^{\circ}C$ unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
Off Charac	cteristics	•	•		•	
BV _{DSS}	Drain-Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0 V, T_J = 25^{\circ} C$	500	-	_	V
$\frac{\Delta BV_{DSS}}{\Delta T_{J}}$	Breakdown Voltage Temperature Coefficient	I _D = 250 μA, Referenced to 25°C	_	0.59	-	V/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 500 V, V _{GS} = 0 V	-	-	1	μΑ
		V _{DS} = 400 V, T _C = 125°C	-	-	10	
I _{GSS}	Gate to Body Leakage Current	$V_{GS} = \pm 30 \text{ V}, V_{DS} = 0 \text{ V}$	_	-	±100	nA
On Charac	cteristics	•				
V _{GS(th)}	Gate Threshold Voltage	$V_{GS} = V_{DS}, I_D = 250 \mu A$	3.0	-	5.0	V
R _{DS(on)}	Static Drain to Source On Resistance	V _{GS} = 10 V, I _D = 14 A	-	0.122	0.155	Ω
9FS	Forward Transconductance	V _{DS} = 20 V, I _D = 14 A	_	34	_	S
Dynamic 0	Characteristics					
C _{iss}	Input Capacitance	$V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	_	3866	5140	pF
C _{oss}	Output Capacitance		_	576	766	pF
C _{rss}	Reverse Transfer Capacitance		-	42	63	pF
Q _{g(tot)}	Total Gate Charge at 10 V	$V_{DS} = 400 \text{ V}, I_{D} = 28 \text{ A},$	-	80	105	nC
Q _{gs}	Gate to Source Gate Charge	V _{GS} = 10 V (Note 4)	-	21	_	nC
Q_{gd}	Gate to Drain "Miller" Charge		_	32	_	nC
Switching	Characteristics					
t _{d(on)}	Turn-On Delay Time	$V_{DD} = 250 \text{ V}, I_D = 28 \text{ A},$	_	56	122	ns
t _r	Turn-On Rise Time	$V_{GS} = 10 \text{ V R}_{G} = 25 \Omega \text{ (Note 4)}$	_	126	262	ns
t _{d(off)}	Turn-Off Delay Time		-	210	430	ns
t _f	Turn-Off Fall Time		-	110	230	ns
Drain-Sou	rce Diode Characteristics and Maximum	Ratings				
I _S	Maximum Continuous Drain to Source Diode Forward Current		-	-	28	Α
I _{SM}	Maximum Pulsed Drain to Source Diode Forward Current		-	-	112	Α
V_{SD}	Drain-Source Diode Forward Voltage	V _{GS} = 0 V, I _{SD} = 20 A	-	_	1.4	V
t _{rr}	Reverse Recovery Time	V _{GS} = 0 V, I _{SD} = 20 A,	_	530	_	ns
Q _{rr}	Reverse Recovery Charge	dl _F /dt = 100 A/μs	_	8	_	μС

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

- 1. Repetitive Rating: Pulse–width limited by maximum junction temperature.
 2. L = 6.1 mH, I_{AS} = 28 A, V_{DD} = 50 V, R_{G} = 25 Ω , starting T_{J} = 25°C.
 3. $I_{SD} \le$ 28 A, di/dt \le 200 A/ μ s, $V_{DD} \le$ BV $_{DSS}$, starting T_{J} = 25°C.
 4. Essentially independent of operating temperature typical Characteristics.



TYPICAL CHARACTERISTICS

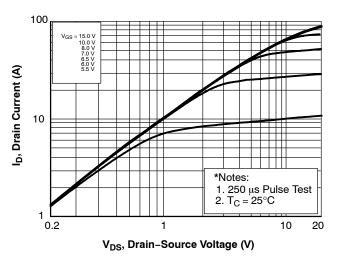


Figure 1. On-Region Characteristics

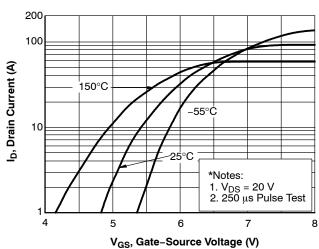


Figure 2. Transfer Characteristics

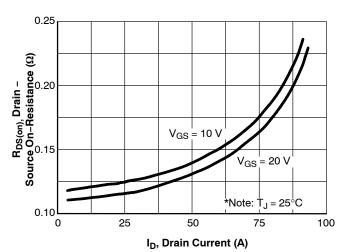


Figure 3. On-Resistance Variation vs Drain Current and Gate Voltage

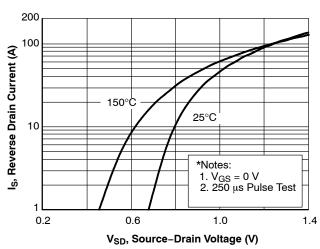


Figure 4. Body Diode Forward Voltage Variation vs Source Current and Temperature

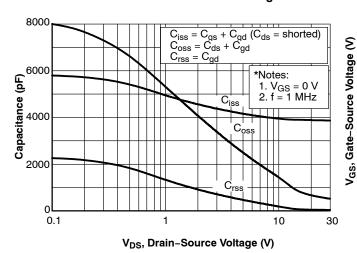


Figure 5. Capacitance Characteristics

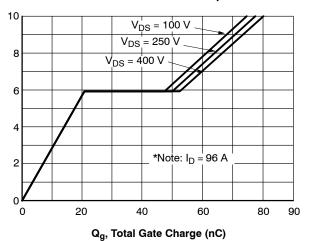


Figure 6. Gate Charge Characteristics

TYPICAL CHARACTERISTICS (CONTINUED)

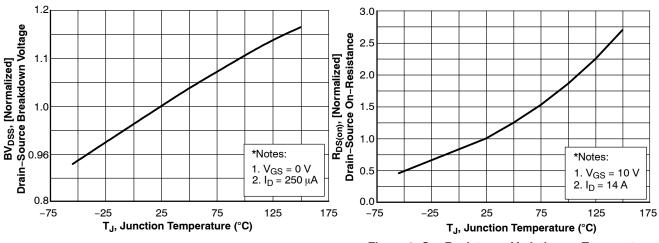


Figure 7. Breakdown Voltage Variation vs Temperature

Figure 8. On-Resistance Variation vs Temperature

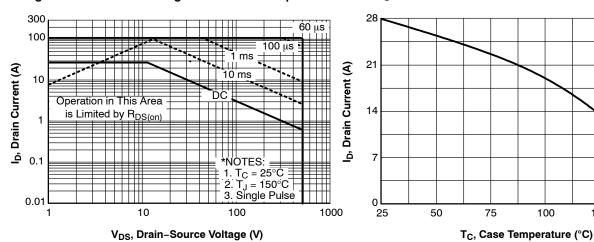


Figure 9. Maximum Safe Operating Area

Figure 10. Maximum Drain Current vs. Case Temperature

125

150

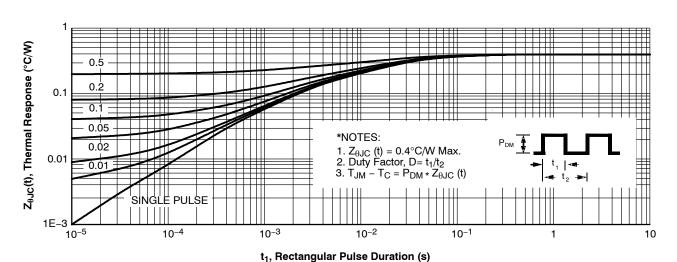


Figure 11. Transient Thermal Response Curve

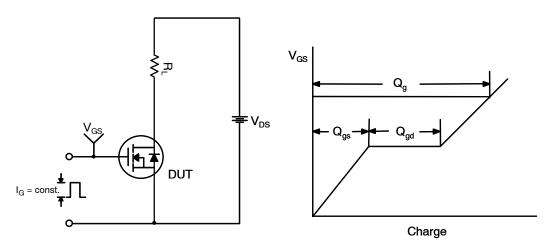


Figure 12. Gate Charge Test Circuit & Waveform

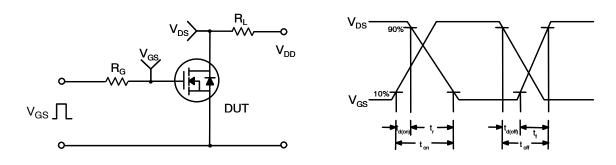


Figure 13. Resistive Switching Test Circuit & Waveforms

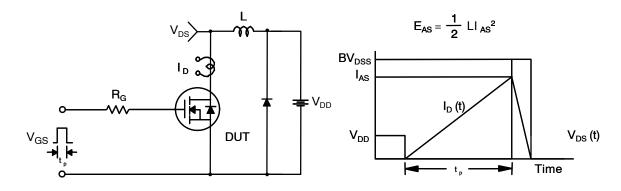
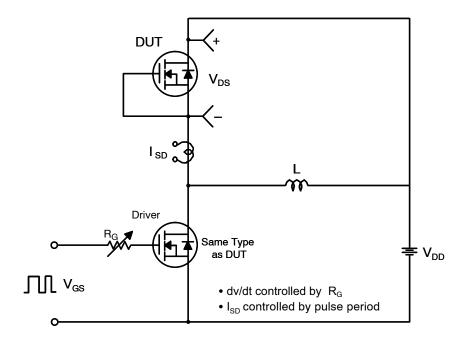
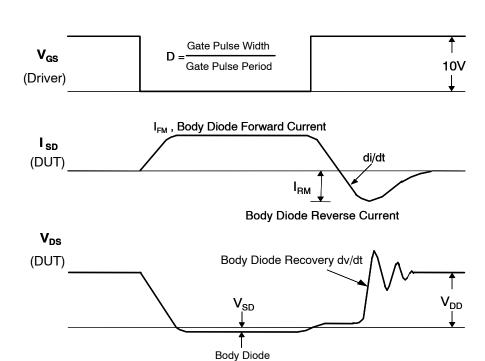


Figure 14. Unclamped Inductive Switching Test Circuit & Waveforms





Forward Voltage Drop

Figure 15. Peak Diode Recovery dv/dt Test Circuit & Waveforms

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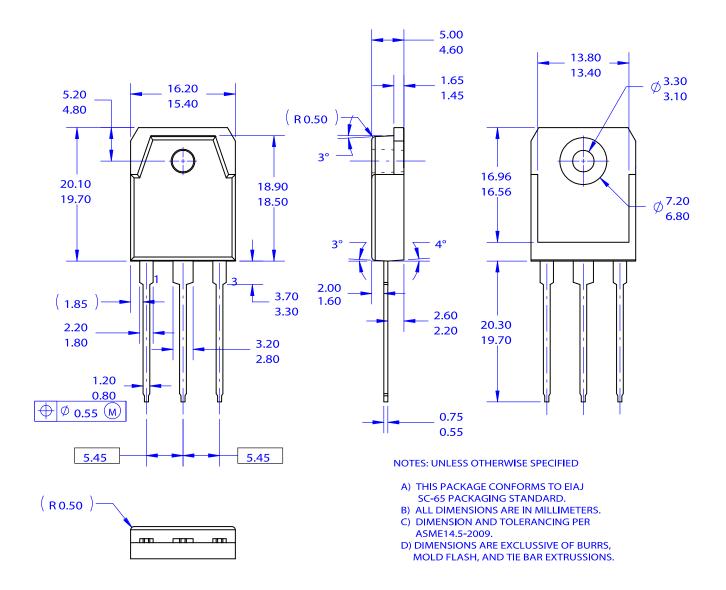


MECHANICAL CASE OUTLINE

PACKAGE DIMENSIONS

TO-3P-3LD / EIAJ SC-65, ISOLATED CASE 340BZ ISSUE O

DATE 31 OCT 2016



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